

# SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDFS066A – MARCH 1987 – REVISED OCTOBER 1993

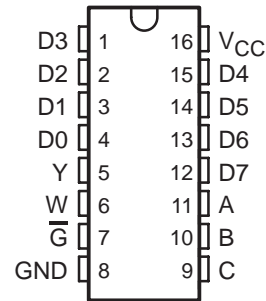
- 3-State Versions of SN54F151B and SN74F151B
- 3-State Outputs Interface Directly With System Bus
- Performs Parallel-to-Serial Conversion
- Complementary Outputs Provide True and Inverted Data
- Package Options Include Plastic Small-Outline Packages, Ceramic Chip Carriers, and Standard Plastic and Ceramic 300-mil DIPs

## description

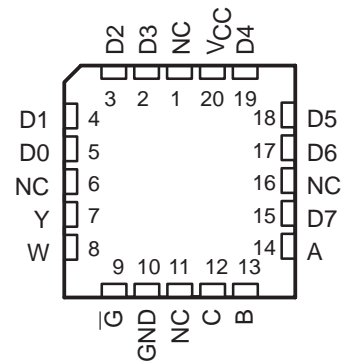
These data selectors/multiplexers contain full binary decoding to select one of eight data sources and feature strobe-controlled complementary outputs. The 3-state outputs can interface with and drive data lines of bus-organized systems. When the strobe ( $\overline{G}$ ) input is high, both outputs are in a high-impedance state in which both the upper and lower transistors of each totem-pole output are off, and the output neither drives nor loads the bus significantly.

The SN54F251B is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74F251B is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

SN54F251B . . . J PACKAGE  
SN74F251B . . . D OR N PACKAGE  
(TOP VIEW)



SN54F251B . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

FUNCTION TABLE

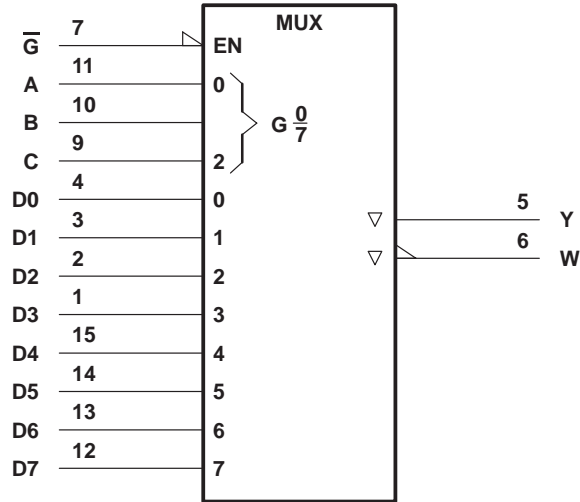
INPUTS				OUTPUTS	
SELECT			STROBE	Y	W
C	B	A	$\overline{G}$		
X	X	X	H	Z	Z
L	L	L	L	D0	$\overline{D0}$
L	L	H	L	D1	$\overline{D1}$
L	H	L	L	D2	$\overline{D2}$
L	H	H	L	D3	$\overline{D3}$
H	L	L	L	D4	$\overline{D4}$
H	L	H	L	D5	$\overline{D5}$
H	H	L	L	D6	$\overline{D6}$
H	H	H	L	D7	$\overline{D7}$

D0, D1, . . . D7 = the level of the respective D input.

# SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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logic symbol†

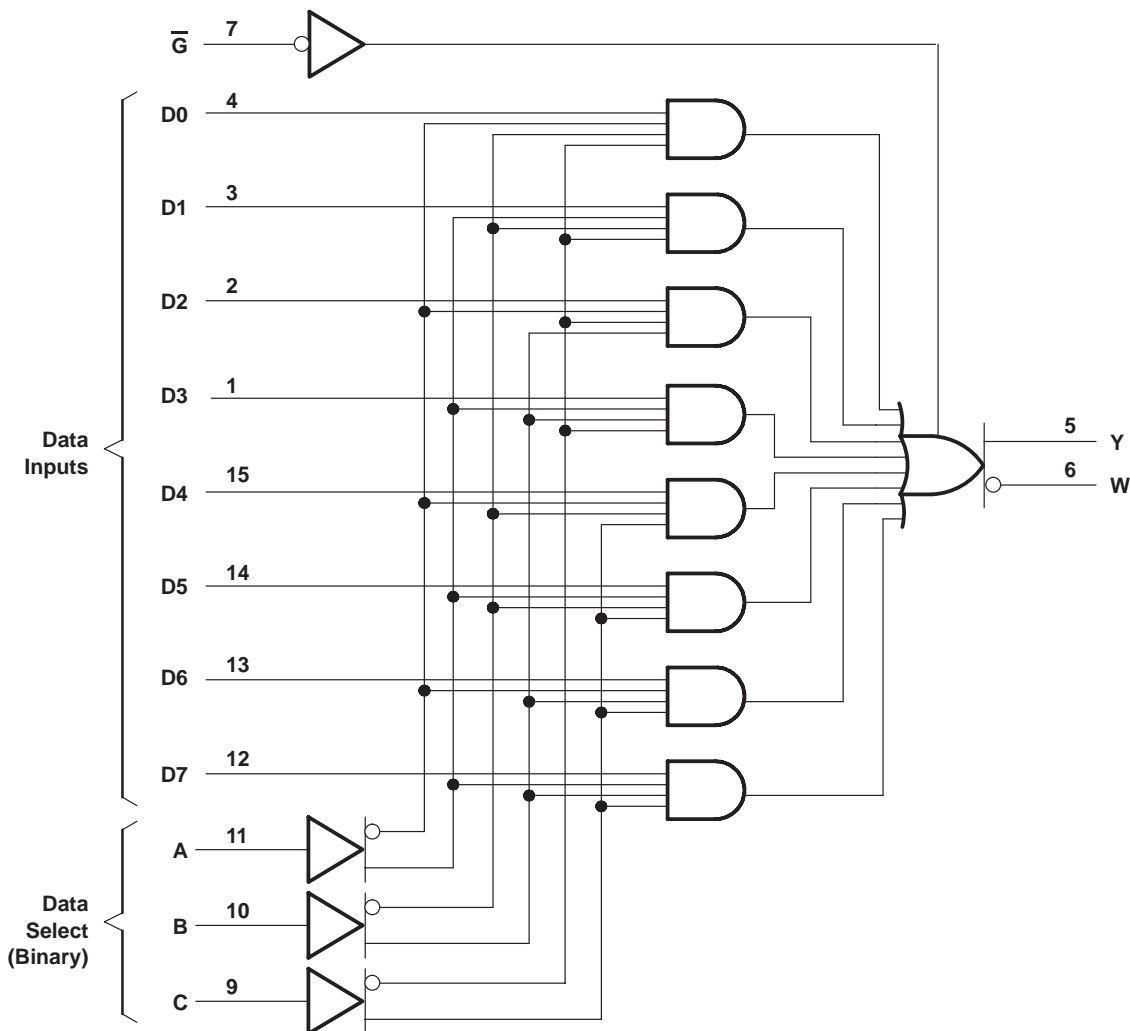


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.  
Pin numbers shown are for the D, J, and N packages.

# SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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logic diagram (positive logic)



Pin numbers shown are for the D, J, and N packages.

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range (see Note 1) .....	-1.2 V to 7 V
Input current range .....	-30 mA to 5 mA
Voltage range applied to any output in the disabled or power-off state .....	-0.5 V to 5.5 V
Voltage range applied to any output in the high state .....	-0.5 V to $V_{CC}$
Current into any output in the low state: SN54F251B .....	40 mA
SN74F251B .....	48 mA
Operating free-air temperature range: SN54F251B .....	-55°C to 125°C
SN74F251B .....	0°C to 70°C
Storage temperature range .....	-65°C to 150°C

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



# SN54F251B, SN74F251B 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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## recommended operating conditions

		SN54F251B			SN74F251B			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
$V_{CC}$	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
$V_{IH}$	High-level input voltage	2			2			V
$V_{IL}$	Low-level input voltage			0.8			0.8	V
$I_{IK}$	Input clamp current			-18			-18	mA
$I_{OH}$	High-level output current			-3			-3	mA
$I_{OL}$	Low-level output current			20			24	mA
$T_A$	Operating free-air temperature	-55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54F251B			SN74F251B			UNIT	
			MIN	TYP†	MAX	MIN	TYP†	MAX		
$V_{IK}$	$V_{CC} = 4.5\text{ V}$ ,	$I_I = -18\text{ mA}$			-1.2			-1.2	V	
$V_{OH}$	$V_{CC} = 4.5\text{ V}$	$I_{OH} = -1\text{ mA}$	2.5	3.4		2.5	3.4		V	
		$I_{OH} = -3\text{ mA}$	2.4	3.3		2.4	3.3			
	$V_{CC} = 4.75\text{ V}$ ,	$I_{OH} = -1\text{ mA to } -3\text{ mA}$				2.7				
$V_{OL}$	$V_{CC} = 4.5\text{ V}$	$I_{OL} = 20\text{ mA}$		0.3	0.5				V	
		$I_{OL} = 24\text{ mA}$				0.35	0.5			
$I_{OZH}$	$V_{CC} = 5.5\text{ V}$ ,	$V_O = 2.7\text{ V}$			50			50	μA	
$I_{OZL}$	$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0.5\text{ V}$			-50			-50	μA	
$I_I$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 7\text{ V}$			0.1			0.1	mA	
$I_{IH}$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 2.7\text{ V}$			20			20	μA	
$I_{IL}$	$V_{CC} = 5.5\text{ V}$ ,	$V_I = 0.5\text{ V}$			-0.6			-0.6	mA	
$I_{OS}‡$	$V_{CC} = 5.5\text{ V}$ ,	$V_O = 0$			-60			-150	mA	
$I_{CC}$	$V_{CC} = 5.5\text{ V}$ , See Note 2	Condition A		15	22			15	22	mA
		Condition B		16	24			16	24	

† All typical values are at  $V_{CC} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.

NOTE 2:  $I_{CC}$  is measured with the outputs open under the following conditions:

- A. Select input and data input at 4.5 V, output control grounded
- B. All inputs at 4.5 V

# SN54F251B, SN74F251B

## 1-OF-8 DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

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### switching characteristics (see Note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> = 5 V, C <sub>L</sub> = 50 pF, R <sub>1</sub> = 500 Ω, R <sub>2</sub> = 500 Ω, T <sub>A</sub> = 25°C			V <sub>CC</sub> = 4.5 V to 5.5 V, C <sub>L</sub> = 50 pF, R <sub>1</sub> = 500 Ω, R <sub>2</sub> = 500 Ω, T <sub>A</sub> = MIN to MAX †				UNIT
			'F251B			SN54F251B		SN74F251B		
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t <sub>PLH</sub>	A, B, or C	W	3.5	5.4	9	3.5	11.5	3.5	9.5	ns
t <sub>PHL</sub>			2.5	4.4	7.5	2.5	8	2.5	7.5	
t <sub>PLH</sub>	A, B, or C	Y	4.5	6.2	10.5	3.5	14	4	12.5	ns
t <sub>PHL</sub>			4	6	8.5	3	10.9	3.5	9	
t <sub>PLH</sub>	Any D	W	2.5	3.7	6.5	1.8	8	2	7	ns
t <sub>PHL</sub>			1	1.9	4	1	6	1	5	
t <sub>PLH</sub>	Any D	Y	3	3.8	7	2.3	9	2.3	8	ns
t <sub>PHL</sub>			3	4.5	7	2.3	9	2.5	8	
t <sub>PZH</sub>	$\overline{G}$	W	2.5	3.6	6	2	7	2	7	ns
t <sub>PZL</sub>			2.5	3.8	6	2.5	7.5	2.5	6.5	
t <sub>PHZ</sub>	$\overline{G}$	W	1.9	2.5	5.5	1.4	6	1.5	6	ns
t <sub>PLZ</sub>			1	2.4	4.5	1	5	1	4.5	
t <sub>PZH</sub>	$\overline{G}$	Y	3.4	4.8	7	2.7	8.5	2.9	8.5	ns
t <sub>PZL</sub>			2.9	4	7.5	2.6	9	2.6	8	
t <sub>PHZ</sub>	$\overline{G}$	Y	1.9	2.5	5.5	1.7	5.5	1.8	5.5	ns
t <sub>PLZ</sub>			1	2.3	4.5	1	5.5	1	4.5	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 3: Load circuits and waveforms are shown in Section 1.





**PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74F251BD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	F251B	
SN74F251BDR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	F251B	Samples
SN74F251BN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74F251BN	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74F251BDR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74F251BDR	SOIC	D	16	2500	353.0	353.0	32.0

**TUBE**


\*All dimensions are nominal



Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN74F251BN	N	PDIP	16	25	506	13.97	11230	4.32
SN74F251BN	N	PDIP	16	25	506	13.97	11230	4.32

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



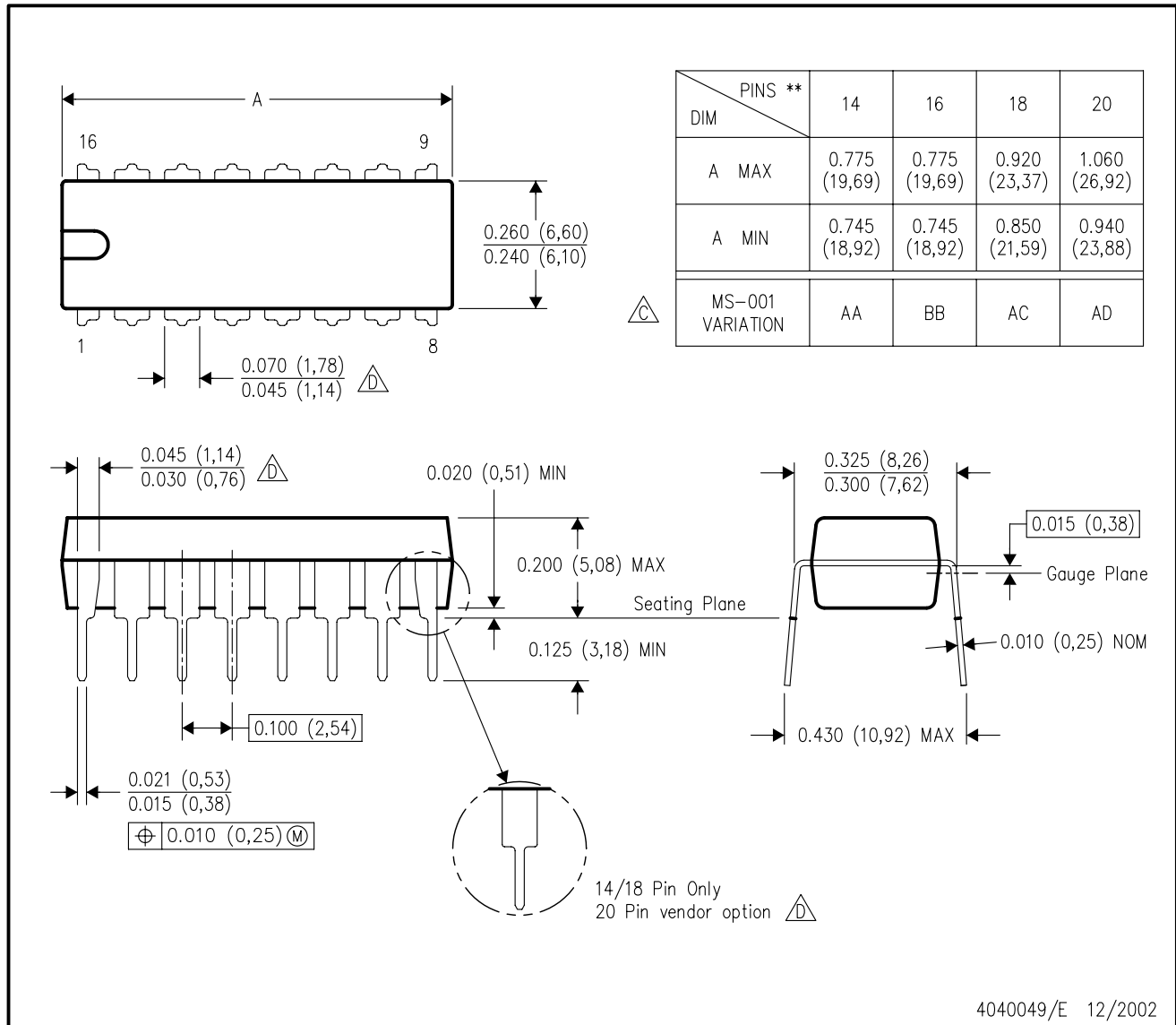
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- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  -  C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
  -  D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
  - E. Reference JEDEC MS-012 variation AC.

N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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